

Part Number : 716617030

Series Number : 71661 Product Category : PCB Headers and Receptacles

Product Description : 1.27mm Pitch EBBI 50D Plug, Vertical, Blind Mate, 30 Circuits, 2.79mm PC Tail Length Status : New Business Not Supported

Documents & Resources

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	(
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2022)9120-DC (17 Jan 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status

Category	PCB Headers and Receptacles
Series	71661
Description	1.27mm Pitch EBBI 50D Plug, Vertical, Blind Mate, 30 Circuits, 2.79mm PC Tail Length
Application	Board-to-Board, Signal, Wire-to- Board
Component Type	PCB Header
Product Family	EBBI 50D Connector System
Product Name	EBBI
UPC	800755009446

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	1.0A
Voltage - Maximum	30V

Physical

Breakaway	No
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	2000
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	Yes
Keying to Mating Part	None
Lock to Mating Part	None
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic

Net Weight	1.968/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tray
PC Tail Length	2.79mm
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	1.27mm
Pitch - Termination Interface	1.27mm
Plating min - Mating	0.762µm
Plating min - Termination	1.905µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	40
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	3
Max-Temp	260

This document was generated on Apr 11, 2024